506790471 07/29/2021

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MASAYOSHI NAKAMURA	11/05/2019
KENDRICK ESPERANZA WONG	11/01/2019

RECEIVING PARTY DATA

Name:	KYOCERA DOCUMENT SOLUTIONS INC.	
Street Address:	1-2-28, TAMATSUKURI, CHUO-KU	
City:	OSAKA	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16699493

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	HORI_29_NOV_2019_NM	
NAME OF SUBMITTER:	NATHAN FEDDE	
SIGNATURE:	/Nathan Fedde/	
DATE SIGNED:	07/29/2021	
	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 3

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PATENT 506790471 REEL: 057011 FRAME: 0974

DECLARATION AND ASSIGNMENT FOR PATENT APPLICATIONS

発明の名称 Title of Invention IMAGE PROCESSING APPARATUS, IMAGE FORMING APPARATUS, AND IMAGE PROCESSING METHOD FOR IMPROVING PERFORMANCE OF READING DATA OF RIP PROCESS

特許出願宣言書

下記の氏名の発明者として、私は以下の通り宣言します

本宣誓は添付されている、あるいは

上記の出願は私自身、あるいは私が権限を授与したものによって行われたものです。

私は本出願書中にあらわれるもともとの発明者、あるいはもともとの共同発明者です。

本宣誓書において故意に虚偽の申し立てを行った場合は 18 U.S.C. 1001 により、罰金あるいは最高五(5)年の禁固刑、あるいはその両方による罰則の対象となることを認めます。

Declaration For Patent Application

As a below-named inventor, I hereby declare that:

This declaration is directed to: the attached application.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Assignment

WHEREAS I, a below-named inventor, having residence and mailing address as set forth below with the signature block,

have invented or co-invented one or more inventions for which an application for a non-provisional Letters Patent of the United States having the above-identified title, and which is filed on or about (said one or more inventions and said application hereinafter referred to individually and collectively as "INVENTIONS"),

WHEREAS, KYOCERA Document Solutions Inc., operating under the laws of the Japan, and having a place of business at 1-2-28, Tamatsukuri, Chuo-ku, Osaka-shi, Osaka, 540-8585 Japan (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring my entire interest therein;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell, assign, and transfer and set over, unto said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under INVENTIONS and all divisions, renewals, and continuations thereof, and all patents of the United States which may be granted thereon and all reissues, reexaminations and

PATENT REEL: 057011 FRAME: 0975 extensions thereof; and all Patents of the United States which may be granted thereon and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for INVENTIONS in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from INVENTIONS under Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models and designs, which may be granted for INVENTIONS in any country or countries foreign to the United States and all extensions, renewals, reexaminations and reissues thereof;

I HEREBY authorize and requests the Commissioner of Patents and Trademarks of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

I HEREBY grant Hawaii Patent Services the power to insert in this Assignment any further identification or information which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

I HEREBY further covenant and agree to communicate to ASSIGNEE, its successors, legal representatives and assigns, any facts known respecting INVENTIONS, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue, reexamination and foreign applications, make all rightful oaths, and generally do everything possible to aid ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for INVENTIONS in all countries.

In witness whereof, executed by me on the date opposite my name.

Legal name of inventor: Masayoshi NAKAMURA

Inventor's Signature: Man / MK

Date: //, 5, 20/9 Residence: Osaka, Japan

Mailing Address: 1-2-28, Tamatsukuri, Chuo-ku, Osaka-shi, Osaka, 540-8585 Japan

(Additional Signature Page Follows)

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(Additional Signature Page)

Legal name of inventor: Kendrick Esperanza Wong

Inventor's Signature:

Date: /// / 2019

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PATENT REEL: 057011 FRAME: 0977

RECORDED: 07/29/2021